



## **ECPE Guideline PSRRA 01**

### **Railway Applications HV-H3TRB tests for Power Semiconductor**

Release no.: 01.12/2019

Release date: 20.12.2019

Contact: ECPE European Center for Power Electronics e.V.  
Dr. Chris Gould  
Landgrabenstrasse 94  
90443 Nuremberg, Germany  
Email [chris.gould@ecpe.org](mailto:chris.gould@ecpe.org)  
Phone (+49) 911 8102 880

## Preface

This Guideline was prepared by the ECPE Working Group 'Power Semiconductor Reliability for Railway Application' comprising ECPE member companies active in the Railway and Semiconductor sectors.

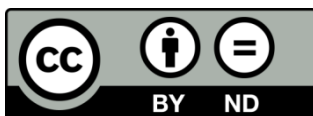
The official version of the Guideline released by the ECPE Working Group is a public document available on the ECPE web site ([www.ecpe.org](http://www.ecpe.org)).

## Legal disclaimer

No liability shall attach to ECPE e.V. or its directors, employees, member organizations or members of the responsible ECPE working group for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication of, use of, or reliance upon, this ECPE Guideline or any other ECPE publications.

ECPE guidelines and publications are adopted without regard to whether or not their adoption may involve patents or articles, materials, or processes. By such action ECPE does not assume any liability to any patent owner, nor does it assume any obligation whatever to parties adopting the ECPE guidelines or publications.

The ECPE Guideline PSRRA 01 is owned by ECPE European Center for Power Electronics e.V.



This ECPE Guideline PSRRA 01 is licensed under a Creative Commons license (license model CC BY ND) - with credit and sharing under the same conditions.

# Railway Applications HV-H3TRB tests for Power Semiconductor

**Contents**

- 1 Scope.....4**
- 2 Normative references.....4**
- 3 Abbreviations .....4**
- 4 Definitions .....5**
  - 4.1 HV-H3TRB-Test.....5
  - 4.2 Voltage classes:.....5
- 5 General conditions.....5**
- 6 Test requirements for the HV-H3TRB.....6**
  - 6.1 Definition of test voltages.....6
  - 6.2 Definition of test temperature.....6
  - 6.3 Definition of test humidity.....6
  - 6.4 Acceptance criteria .....6
  - 6.5 Test duration .....8
  - 6.6 Ramp-up .....8
  - 6.7 Ramp-down.....8
  - 6.8 Stabilization phase after the test.....8
- 7 Diagram index.....9**
- 8 Table index.....9**

## 1 Scope

This document describes a steady-state temperature, humidity and voltage bias test for the evaluation of the behavior of non-hermetically sealed power electronic IGBT and SiC MOSFET modules for the use in rolling stock applications.

## 2 Normative references

Standard	Date of Issue	Title
IEC 60749-5	2017-04	Semiconductor devices – Mechanical and climatic test methods – Part 5: Steady-state temperature humidity bias test
IEC 60068-2-67	1995	Environmental testing – Part 2-67: Tests – Test Cy: Damp heat, steady state, accelerated test primarily intended for components
IEC 60747-9	2007-09	Semiconductor devices – Discrete devices – Part 9: Insulated-gate bipolar transistor (IGBTs)
IEC 60747-2	2016-04-13	Semiconductor devices - Part 2: Discrete devices - Rectifier diodes
IEC 60747-15	2010-12-16	Semiconductor devices - Discrete devices - Part 15: Isolated power semiconductor devices
IEC 62497-2	2010-02-18	Railway applications — Insulation coordination Part 2: Overvoltages and related protection

## 3 Abbreviations

DS	Datasheet
$T_a$	Ambient temperature
$T_{vjmax}$	Maximum virtual junction operation temperature
$T_{vj\_initial}$	$T_{vj}$ at the starting phase of the test
$R_{THja}$	Thermal resistivity between junction and ambient
$V_{ISO}$	Isolation test voltage
$V_{bias}$	Applied $V_{CES}$ test voltage
$V_{CES}$	Collector-Emitter voltage with Gate-Emitter short-circuited
$V_{DSS}$	Drain-Source voltage with Gate-Source short-circuited
$U_{max1}$	Highest permanent DC catenary voltage
$U_{max2}$	Highest non-permanent DC catenary voltage
$U_{max3}$	Highest temporary Over-voltages
$V_{CEsat}$	Collector-Emitter saturation voltage of IGBT
$R_{DS(on)}$	Drain-Source on-resistance of MOSFETs
$V_F$	Forward voltage drop of Diode

$V_{SD}$	Forward voltage of the internal body diode (corresponds to the voltage of the Drain-Source path in reverse operation)
$V_{GE,th}$	Gate-Emitter threshold voltage of IGBT
$V_{GS,th}$	Gate-Source threshold voltage
$I_{CES}$	Collector-Emitter cut-off current, Gate-Emitter short-circuited
$I_{GES}$	Gate leakage current, Collector-Emitter short-circuited
$I_{DSS}$	Drain-Source leakage current
$I_{GSS}$	Gate-Source leakage current

## 4 Definitions

### 4.1 HV-H3TRB-Test

HV-H3TRB is conducted in a same/similar way as the IEC60068-2-67 and IEC 60749-5 standard, with the addition of clearly defining the test voltage to be applied in relation of the device voltage class.

### 4.2 Voltage classes:

The test is applicable for the standard IGBT and SiC MOSFET power module voltage classes for rolling stock applications, ranging up to 6500V.

## 5 General conditions

The general test conditions are as defined in the IEC60068-2-67 and IEC 60749-5 standards. Specifically, the standard test temperature and relative humidity are set to 85°C and 85%. The ramp-up, the ramp-down, the drying and the test durations are defined separately in this document.

The following definition shows typical number of test devices with new chip design and new packages. The use of generic "family data" to simplify the qualification process is accepted.

Recommended number of samples:

Criteria	Sample number
Min. number of modules	9
Min. number of modules per lot	3
Min. number of module prod. lots	3
Min. number of chips	72 (IGBT and diodes each)
Min. number of chip prod. lots	3

## 6 Test requirements for the HV-H3TRB

### 6.1 Definition of test voltages

The test voltage is not regarded as acceleration factor for the test. Thus, the test voltage is selected in the range of the typical use case and defined dependent on the voltage class. In general, the test voltage is defined to fulfill the requirements of  $U_{max2}$  for 750 V, 1500 V and 3000 V catenary voltage according to IEC 62497-2, table A.1 – Overvoltages. This is reached by setting  $V_{bias}$  at approximately  $60\% \times V_{CES}$  respectively  $V_{DSS}$ .

As an exception to this rule, 3000V is set as test voltage for 4500V devices. DC link voltage for applications using 4.5kV semiconductors is set between 2200V and 3000V. DC link with certain tolerance of the control chain has to be taken into account.

**Table 1: Summary of the test voltage for the typical voltage classes of power modules for traction applications and the maximum voltages from IEC 62497-2**

Voltage class of power modules	1700V	3300V	4500V	6500V
HV-H3TRB Test voltage Minimum test voltage	1000 V	1950 V	3000V	3900V
Nominal line voltage $U_n$	750V	1500V	-	3000V
Highest permanent DC catenary voltage $U_{max1}$	900V	1800V	-	3600V
Highest non-permanent DC catenary voltage $U_{max2}$	1000	1950	-	3900V
Highest temporary Over-voltages $U_{max3}$	1270V	2540	-	5075V

### 6.2 Definition of test temperature

The test temperature is defined as the ambient temperature in the test chamber and shall be set to 85°C. The tolerance for the temperature is  $\pm 2^\circ$  according IEC 60068-2-67.

If the difference between  $T_a$  and  $T_{vj\_initial}$  is  $> 10\text{ K}$   $\rightarrow$  Action to reduce Delta T below 10 K shall be taken into account. Potential measures can be the reduction of  $R_{THja}$  and / or reduction of mean losses by application of cycled biased voltage. The test clock runs between ramp-up and ramp-down and only, when voltage is applied.

Changes in the test control strategy in order to control the junction temperature has to be monitored and protocolled.

### 6.3 Definition of test humidity

The test humidity is defined as the relative humidity in the test chamber.

The test humidity shall be set to 85%. The tolerance for the humidity is  $\pm 5\%$  according IEC 60068-2-67.

### 6.4 Acceptance criteria

The acceptance criteria are split in two parts, the in-test and the post-test criteria.

The "in-test" means during the test, the "post-test" after the test. The sampling rate for in-test shall be minimum once per hour.

**The in-test acceptance criteria**

$I_{CES} < 10 \times I_{CES\_initial}$  respectively  $I_{DSS} < 10 \times I_{DSS\_initial}$  (initial leakage current measured after stabilization of the test @  $V_{bias}$ ). In addition, values under  $100\mu A$  are to be considered as below the measurement resolution. Initial leakage currents below  $100\mu A$  should be considered as  $100\mu A$ .

No breakdown of voltage  $V_{CES}$ , respectively  $V_{DSS}$ .

**The post-test acceptance criteria are described in Table 2**

Prior to HV-H3TRB test an initial characterization has to be done that includes all parameters according to Table 2.

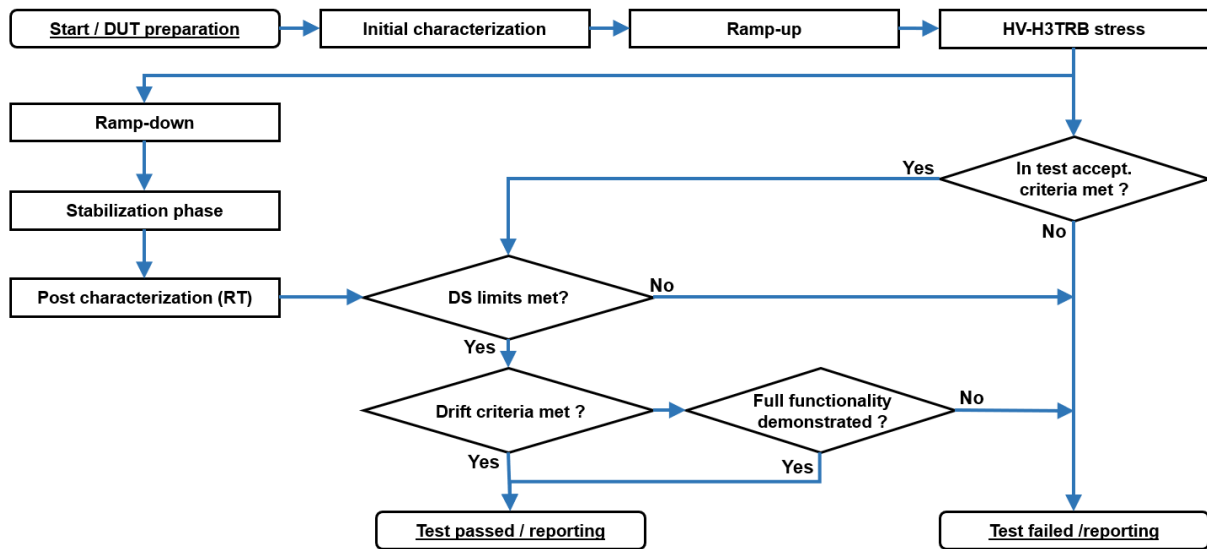
Room temperature post characterization tests shall be performed before any test at higher temperature. The following table summarizes the acceptance criteria after the HV-H3TRB test.

**Table 2: Post-test acceptance criteria**

Value	Test temperature	Acceptance criteria
$V_F / V_{SD}$	room temperature	within DS-limits AND drift <10%
$V_{CEsat} / R_{DS(on)}$	room temperature	within DS-limits AND drift <10%
$V_{GE,th} / V_{GS,th}$	room temperature	within DS-limits AND drift <10%
$I_{CES} / I_{DSS}^*$	room temperature	within DS-limits AND drift < $x10^*$
$I_{GES} / I_{GSS}^*$	room temperature	within DS-limits AND drift < $x10^*$
$V_{ISO} \text{ minimum}$	room temperature	80% of $V_{ISO}$

\*  $I_{CES} / I_{DSS}$  values below  $100 \mu A$  and  $I_{GES} / I_{GSS}$  below  $100 \text{ nA}$  are to be considered as below the measurement resolution. Initial leakage currents below  $100\mu A$  or  $100\text{nA}$  respectively should be considered as  $100\mu A$  ( $100\text{nA}$ ).

In case drift criteria are not met but devices are still within specified limits a risk release is possible by proving that functionality under operation conditions is still given as depicted in Figure 1 below:



**Figure 1:** Test and assessment flow-chart (at all decision points pass decision is only possible if all samples pass)

**6.5 Test duration**

Test duration under voltage shall be 1000 (+168/-24) h. As alternative, end-of-life (EOL) testing is also allowed and recommended for new technologies up to 2000 h as maximum test duration.

Final qualification shall be done in 1 run without intermediate readouts in order to avoid reduction of test stress by retarded humidity intrusion.

**6.6 Ramp-up**

The procedure as defined in chapter 7 of IEC 60749-05 applies. The time to reach stable temperature and relative humidity conditions should be less than 3 h. Condensation shall be avoided by ensuring that the test chamber (dry bulb) temperature exceeds the wet-bulb temperature at all times.

**6.7 Ramp-down**

The procedure as defined in chapter 7 of IEC 60749-05 applies. Ramp-down to stabilization condition should not exceed 3 h. Condensation shall be avoided by ensuring that the test chamber (dry bulb) temperature exceeds the wet-bulb temperature at all times.

**6.8 Stabilization phase after the test**

The drying process should be defined for each product. The objective is to get humidity sensitive parameters independent of the captured humidity. The drying process conditions shall be kept unchanged for each product.

The preferred procedure is defined in chapter 7 of IEC 60749-05 with modifications based on the specifics of IGBT power modules. An electrical test shall be performed not later than 48 h after the end of ramp-down which shall include at minimum testing of reverse blocking current and reverse blocking voltage. Within this time window drying by tempering is allowed if room temperature storage is not sufficient to dry out excessive humidity. A deviation of this baseline procedure shall be documented and reasoned in the procurement document.



**7 Diagram index**

Figure 1: Test and assessment flow-chart (at all decision points pass decision is only possible if all samples pass) ..... 8

**8 Table index**

Table 1: Summary of the test voltage for the typical voltage classes of power modules for traction applications and the maximum voltages from IEC 62497-2 ..... 6

Table 2: Post-test acceptance criteria ..... 7